S/N 09/615,922

<u>IN THE UNITED STATES PATENT AND TRADEMARK OFFICE</u>

Applicant:

George K. Korinsky et al.

Examiner: Gregory Thompson

Serial No.:

09/615,922

Group Art Unit: 2835

Filed:

July 13, 2000

Docket: 884.298US1

Title:

METHOD AND APPARATUS FOR DISSIPATING HEAT FROM AN

**ELECTRONIC DEVICE** 

## **AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Commissioner for Patents Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on <u>July 5, 2002</u>. Please amend the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a three-month extension of the period for responding to the Office action, thereby moving the deadline for response from October 5, 2002 to January 5, 2003, which is a Sunday.

## **IN THE DRAWINGS**

Please substitute originally-filed drawing sheets corresponding to Figure 9 with red-lined drawing sheet corresponding to Figure 9 enclosed herewith. Figure 9 is amended to correct typographical errors. A complete set of formal drawings is also enclosed.

## **IN THE SPECIFICATION**

Please make the paragraph substitutions indicated in the appendix entitled "Clean Version of Amended Specification Paragraphs". The specific changes incorporated in the substitute paragraphs are shown in the following marked-up versions of the original paragraphs.

The paragraph beginning on page 5, line 4 is amended as follows:

The housing 202 is adapted to be closely fitted to a heat sink. The housing 202 has a first end 204 and a second end 206. The first end 204 is adapted to hold [a] an air moving device 203. In one embodiment, the housing 202 attaches to a processor socket. In one embodiment, various cooling attachments can be attached to the first end 204 and the second end 206 of the housing 202 to provide a multitude of thermal solutions for high performance electronic devices.

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